Data sheet

Schottky Barrier Diode

| V_{R} | 90 | V |
|----------------|----|---|
| l _o | 1 | Α |
| IFSM | 50 | А |

Package Code | SOD-128 | JEITA Code | - ROHM Code | PMDTM | (1)

Outline

◆ Features
 High reliability
 Small power mold type
 Low V_F

- ApplicationGeneral rectification
- StructureSilicon epitaxial planar

Packaging Specifications

| C : doitagning opcomeducine | | | | |
|-----------------------------|---------------|--|--|--|
| Packing | Embossed Tape | | | |
| Reel Size(mm) | 180 | | | |
| Taping Width(mm) | 12 | | | |
| Basic Ordering Unit(pcs) | 3000 | | | |
| Taping Code | TR | | | |
| Marking | 46 | | | |
| | | | | |

◆ Absolute Maximum Ratings (T_c=25°C unless otherwise specified)

| Parameter | Symbol | Conditions | Limits | Unit |
|-------------------------------------|------------------|---|------------------|------|
| Repetitive peak reverse voltage | V_{RM} | Duty≦0.5 | 95 | V |
| Reverse voltage | V_{R} | Reverse direct voltage | 90 | V |
| Average rectified forward current | lo | Glass epoxy mounted、 60Hz half sin wav eform, resistiv e load、 T _c =130°c Max. | 1 | А |
| Peak forward surge current | I _{FSM} | 60Hz half sin waveform, Non-repetitive, one cycle, T _a =25°c | 50 | А |
| Junction temperature ⁽¹⁾ | Tj | - | 150 | °C |
| Storage temperature | T _{stg} | - | -55 ~ 150 | °C |

Note(1) To avoid occurrence of thermal runaway, actual board is to be designed to fulfill dP_d/dT_i<1/R_{th(i-a)}.

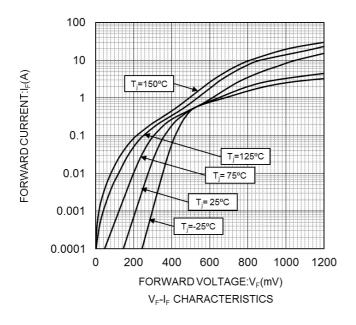
● Characteristics (T_i=25°C unless otherwise specified)

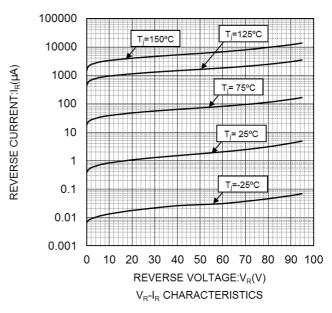
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|-----------------|----------------|---------------------|------|------|------|------|
| Forward voltage | V_{F} | I _F =1A | - | - | 0.73 | V |
| Reverse current | I _R | V _R =90V | - | - | 100 | μA |

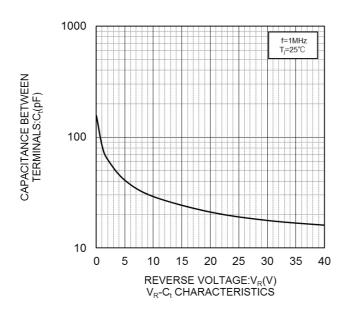
Attention

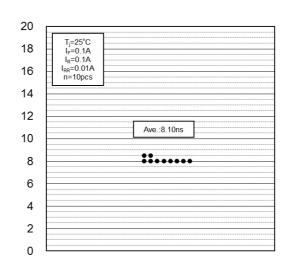
Compared with PN junction diodes, Schottky Barrier Diode is generally high reverse current (IR). The reverse loss of the diode might increase as temperature increasing that causes heat-up and further IR. This phenomenon might end up the thermal destruction(thermal runaway). Therefore please give consideration to the reverse loss and the ambient temperature when using this product.

Characteristic Curves





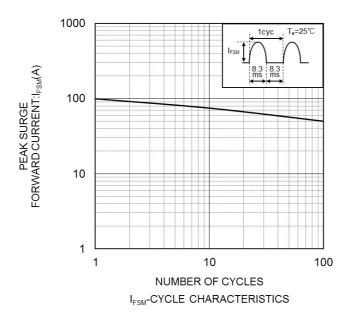


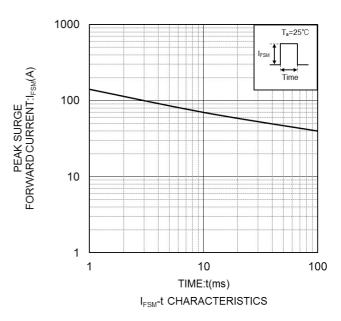


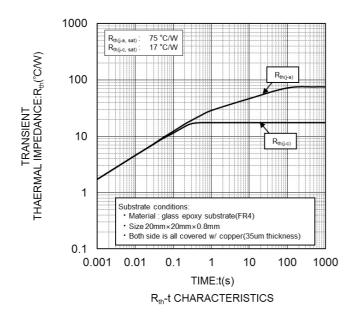
trr DISPERSION MAP

REVERSE RECOVERY TIME:t_{rr}(ns)

Characteristic Curves

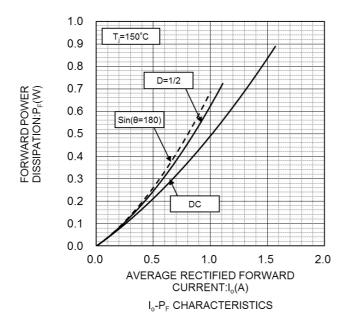


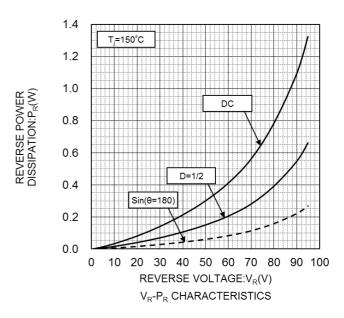


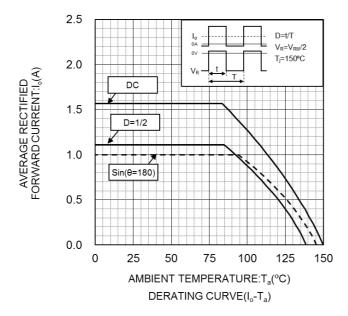


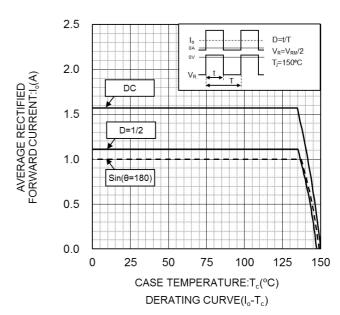
3/5

Characteristic Curves

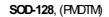


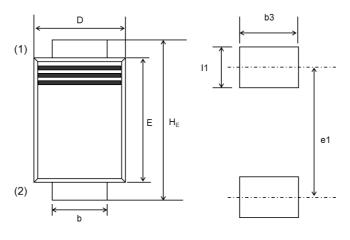


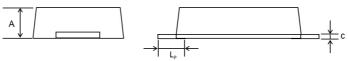




Dimensions



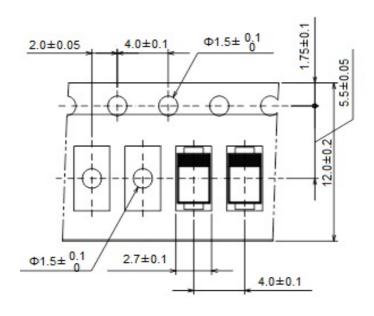


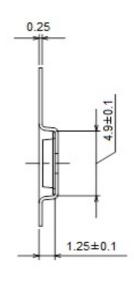


| DIM | Milimeters | | | Inches | | |
|----------------|------------|---------|------|--------|---------|-------|
| Dilvi | Min. | Average | Max. | Min. | Average | Max. |
| Α | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 |
| b | 1.30 | 1.50 | 1.70 | 0.051 | 0.059 | 0.067 |
| С | 0.12 | 0.17 | 0.27 | 0.005 | 0.007 | 0.011 |
| D | 2.30 | 2.50 | 2.70 | 0.091 | 0.098 | 0.106 |
| E | 3.50 | 3.70 | 3.90 | 0.138 | 0.146 | 0.154 |
| HE | 4.56 | 4.70 | 4.84 | 0.180 | 0.185 | 0.191 |
| L _P | - | 0.75 | - | - | 0.030 | - |
| I1 | - | 1.40 | - | - | 0.055 | - |
| b3 | - | 2.00 | - | - | 0.079 | - |
| e1 | - | 4.40 | - | - | 0.173 | - |

- (1) The marking bar indicates the cathode.(2) The direction indicates the anode.

● Taping (Unit:mm)





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| 1 | JÁPAN | USA | EU | CHINA |
|---|----------|---------|------------|--------|
| | CLASSIII | OL ACOM | CLASS II b | ОГУООШ |
| | CLASSIV | CLASSⅢ | CLASSIII | CLASSⅢ |

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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RB160LAM-90 - Web Page

| Part Number | RB160LAM-90 |
|-----------------------------|-------------|
| Package | PMDTM |
| Unit Quantity | 3000 |
| Minimum Package Quantity | 3000 |
| Packing Type | Taping |
| Constitution Materials List | inquiry |
| RoHS | Yes |